GA-H110M-DS2 GA-H110M-DS2 DDR3

User's Manual

Rev. 1002

GA-H110M-DS2



GA-H110M-DS2 DDR3



For more product details, please visit GIGABYTE's website.



To reduce the impacts on global warming, the packaging materials of this product are recyclable and reusable. GIGABYTE works with you to protect the environment.

Declaration of Conformity

We, Manufacturer/Importer,

G.B.T. Technology Trading GMbH

Address: Bullenkoppel 16, 22047 Hamburg, Germany

Declare that the product

Product Type: Motherboard

Product Name: GA-H110M-DS2

conforms with the essential requirements of the following directives:

2004/108/EC EMC Directive:

□ Conduction & Radiated Emissions:	EN 55022:2010			
☑ Immunity:	EN 55024:2010			
Power-line harmonics:	EN 61000-3-2:2006+A2:2009			
Power-line flicker:	EN 61000-3-3:2008			

2006/95/EC LVD Directive

Safety: Safety:	EN60950-1:2006+A12:2011

2011/65/EU RoHS Directive

Restriction of use of certain	This product does not contain any of the restricted
substances in electronic equipm	ent: substances listed in Annex II, in concentrations
	and applications banned by the directive.

□ CE marking



		Signature:	Timmy Huang
(Stamp)	Date: Oct. 28, 2015	Name:	Timmy Huang

DECLARATION OF CONFORMITY

An EST Part 2 Service 2 127-13



Responsible Party Numer G.B.T. (NO. (U.S.A.)

Address: 1795; Ballenat Serv.) City of Endostry, CA 99748

PhoenI'm: No. 1626) 884-8536* (626) 884-8526.

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FCC Part 13. Subgroup, Section 15.100 ground Section 15.129 (9) Class & Digital Device

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Representative Person (s Name): <u>pppd_cd</u>

Signature: 13:44 - 155

Oct. 28, 2015

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		Signature:	ronny, ronny
The same I	Date: Aug 17 2015	Name:	Timmy Huang

DECLARATION OF CONFORMITY

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PhoenI'an No. (624) 454-558/ (626) 654-5524

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Aug. 17, 2015

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- In order to assist in the use of this product, carefully read the User's Manual.
- For product-related information, check on our website at: http://www.gigabyte.com

Identifying Your Motherboard Revision

The revision number on your motherboard looks like this: "REV: X.X." For example, "REV: 1.0" means the revision of the motherboard is 1.0. Check your motherboard revision before updating motherboard BIOS, drivers, or when looking for technical information. Example:

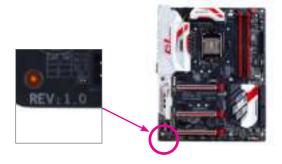
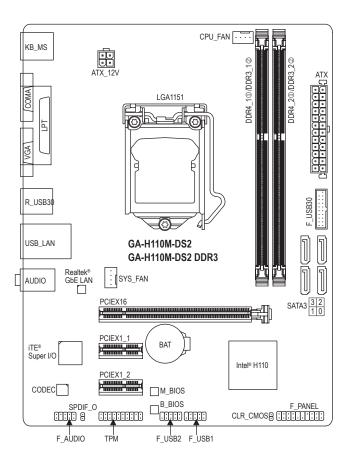


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GA-H110M-DS2/GA-H110M-DS2 DDR3Motherboard Layout



Box Contents

- ☑ GA-H110M-DS2 or GA-H110M-DS2 DDR3 motherboard
- ☑ Motherboard driver disk

✓ Two SATA cables

✓ User's Manual

☑ I/O Shield

^{*} The box contents above are for reference only and the actual items shall depend on the product package you obtain. The box contents are subject to change without notice.

① Only for GA-H110M-DS2.

② Only for GA-H110M-DS2 DDR3.

Chapter 1 Hardware Installation

1-1 Installation Precautions

The motherboard contains numerous delicate electronic circuits and components which can become damaged as a result of electrostatic discharge (ESD). Prior to installation, carefully read the user's manual and follow these procedures:

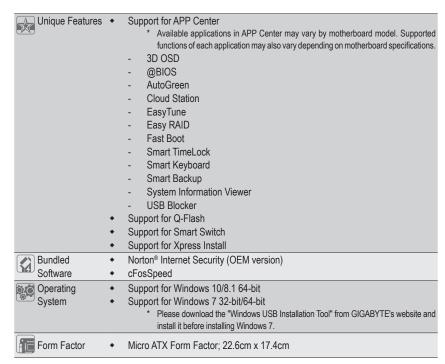
- Prior to installation, make sure the chassis is suitable for the motherboard.
- Prior to installation, do not remove or break motherboard S/N (Serial Number) sticker or warranty sticker provided by your dealer. These stickers are required for warranty validation.
- Always remove the AC power by unplugging the power cord from the power outlet before installing or removing the motherboard or other hardware components.
- When connecting hardware components to the internal connectors on the motherboard, make sure they are connected tightly and securely.
- · When handling the motherboard, avoid touching any metal leads or connectors.
- It is best to wear an electrostatic discharge (ESD) wrist strap when handling electronic components such as a motherboard, CPU or memory. If you do not have an ESD wrist strap, keep your hands dry and first touch a metal object to eliminate static electricity.
- Prior to installing the motherboard, please have it on top of an antistatic pad or within an
 electrostatic shielding container.
- Before connecting or unplugging the power supply cable from the motherboard, make sure the power supply has been turned off.
- Before turning on the power, make sure the power supply voltage has been set according to the local voltage standard.
- Before using the product, please verify that all cables and power connectors of your hardware components are connected.
- To prevent damage to the motherboard, do not allow screws to come in contact with the motherboard circuit or its components.
- Make sure there are no leftover screws or metal components placed on the motherboard or within the computer casing.
- Do not place the computer system on an uneven surface.
- Do not place the computer system in a high-temperature or wet environment.
- Turning on the computer power during the installation process can lead to damage to system components as well as physical harm to the user.
- If you are uncertain about any installation steps or have a problem related to the use of the product, please consult a certified computer technician.
- If you use an adapter, extension power cable, or power strip, ensure to consult with its installation and/or grounding instructions.

1-2 Product Specifications

CPU CPU	 Support for Intel® Core™ i7 processors/Intel® Core™ i5 processors/ Intel® Core™ i3 processors/Intel® Pentium® processors/ Intel® Celeron® processors in the LGA1151 package (Go to GIGABYTE's website for the latest CPU support list.) L3 cache varies with CPU
Chipset	◆ Intel® H110 Express Chipset
Memory ①	2 x DDR4 DIMM sockets supporting up to 32 GB of system memory Due to a Windows 32-bit operating system limitation, when more than 4 GB of physical memory is installed, the actual memory size displayed will be less than the size of the physical memory installed. Dual channel memory architecture Support for DDR4 2133 MHz memory modules Support for ECC UDIMM 1Rx8/2Rx8 memory modules (operate in non-ECC mode) Support for non-ECC UDIMM 1Rx8/2Rx8/1Rx16 memory modules (Go to GIGABYTE's website for the latest supported memory speeds and memory modules.)
Memory@	2 x DDR3 DIMM sockets supporting up to 32 GB of system memory * Due to a Windows 32-bit operating system limitation, when more than 4 GB of physical memory is installed, the actual memory size displayed will be less than the size of the physical memory installed. Dual channel memory architecture Support for DDR3/DDR3L 1600/1333 MHz memory modules Support for ECC UDIMM 1Rx8/2Rx8 memory modules (operate in non-ECC mode) Support for non-ECC UDIMM 1Rx8/2Rx8 memory modules (Go to GIGABYTE's website for the latest supported memory speeds and memory modules.)
Onboard Graphics	Integrated Graphics Processor-Intel® HD Graphics support: 1 x D-Sub port, supporting a maximum resolution of 1920x1200@60 Hz Maximum shared memory of 512 MB
Audio	Realtek® ALC887 codec High Definition Audio 2/4/5.1/7.1-channel * To configure 7.1-channel audio, you have to use an HD front panel audio module and enable the multi-channel audio feature through the audio driver. Support for S/PDIF Out
E_AN LAN	Realtek® GbE LAN chip (10/100/1000 Mbit)
Expansion Slots	1 x PCI Express x16 slot, running at x16 (The PCI Express x16 slot conforms to PCI Express 3.0 standard.) 2 x PCI Express x1 slots (The PCI Express x1 slots conform to PCI Express 2.0 standard.)
Storage Interface	Chipset:4 x SATA 6Gb/s connectors

- ① Only for GA-H110M-DS2. ② Only for GA-H110M-DS2 DDR3.

USB	 Chipset: 4 x USB 3.0/2.0 ports (2 ports on the back panel, 2 ports available through the internal USB header) 6 x USB 2.0/1.1 ports (2 ports on the back panel, 4 ports available through the internal USB headers)
Internal Connectors	 1 x 24-pin ATX main power connector 1 x 4-pin ATX 12V power connector 4 x SATA 6Gb/s connectors 1 x CPU fan header 1 x system fan header 1 x front panel header 1 x front panel audio header 1 x S/PDIF Out header 1 x USB 3.0/2.0 header 2 x USB 2.0/1.1 headers 1 x Trusted Platform Module (TPM) header 1 x Clear CMOS jumper
Back Panel Connectors	 1 x PS/2 mouse port 1 x PS/2 Keyboard port 1 x parallel port 1 x serial port 1 x D-Sub port 2 x USB 3.0/2.0 ports 2 x USB 2.0/1.1 ports 1 x RJ-45 port 3 x audio jacks (Line In, Line Out, Mic In)
I/O Controller	iTE® I/O Controller Chip
Hardware Monitor	 System voltage detection CPU/System temperature detection CPU/System fan speed detection CPU/System overheating warning CPU/System fan fail warning CPU/System fan speed control Whether the fan speed control function is supported will depend on the cooler you install.
BIOS	 2 x 64 Mbit flash Use of licensed AMI UEFI BIOS Support for DualBIOS™ PnP 1.0a, DMI 2.7, WfM 2.0, SM BIOS 2.7, ACPI 5.0



* GIGABYTE reserves the right to make any changes to the product specifications and product-related information without prior notice.

GA-H110M-DS2







Please visit GIGABYTE's website for support lists of CPU, memory modules, and SSDs.



Please visit the **Support\Utility List** page on GIGABYTE's website to download the latest version of anns

1-3 Installing the CPU



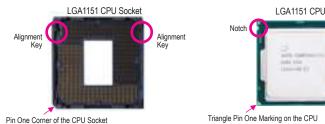
Read the following guidelines before you begin to install the CPU:

- Make sure that the motherboard supports the CPU.
 (Go to GIGABYTE's website for the latest CPU support list.)
- Always turn off the computer and unplug the power cord from the power outlet before installing the CPU to prevent hardware damage.
- Locate the pin one of the CPU. The CPU cannot be inserted if oriented incorrectly. (Or you may locate
 the notches on both sides of the CPU and alignment keys on the CPU socket.)
- Apply an even and thin layer of thermal grease on the surface of the CPU.
- Do not turn on the computer if the CPU cooler is not installed, otherwise overheating and damage
 of the CPU may occur.
- Set the CPU host frequency in accordance with the CPU specifications. It is not recommended
 that the system bus frequency be set beyond hardware specifications since it does not meet the
 standard requirements for the peripherals. If you wish to set the frequency beyond the standard
 specifications, please do so according to your hardware specifications including the CPU, graphics
 card, memory, hard drive, etc.

Notch

Installing the CPU

Locate the alignment keys on the motherboard CPU socket and the notches on the CPU.





Do not remove the CPU socket cover before inserting the CPU. It may pop off from the load plate automatically during the process of re-engaging the lever after you insert the CPU.

1-4 Installing the Memory



Read the following guidelines before you begin to install the memory:

- Make sure that the motherboard supports the memory. It is recommended that memory of the same capacity, brand, speed, and chips be used.
 - (Go to GIGABYTE's website for the latest supported memory speeds and memory modules.)
- Always turn off the computer and unplug the power cord from the power outlet before installing the memory to prevent hardware damage.
- Memory modules have a foolproof design. A memory module can be installed in only one direction.
 If you are unable to insert the memory, switch the direction.

Dual Channel Memory Configuration

This motherboard provides two memory sockets and supports Dual Channel Technology. After the memory is installed, the BIOS will automatically detect the specifications and capacity of the memory. Enabling Dual Channel memory mode will double the original memory bandwidth.



Please visit GIGABYTE's website for details on hardware installation.

The two DDR4 memory sockets are divided into two channels and each channel has one memory socket as following ①:

Channel A: DDR4_1Channel B: DDR4_2

The two DDR3 memory sockets are divided into two channels and each channel has one memory socket as following:

Channel A: DDR3_1Channel B: DDR3_2

Due to CPU limitations, read the following guidelines before installing the memory in Dual Channel mode.

- 1. Dual Channel mode cannot be enabled if only one memory module is installed.
- When enabling Dual Channel mode with two memory modules, it is recommended that memory of the same capacity, brand, speed, and chips be used for optimum performance.

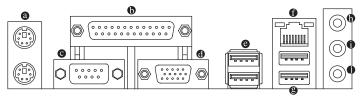
1-5 Installing an Expansion Card



Read the following guidelines before you begin to install an expansion card:

- Make sure the motherboard supports the expansion card. Carefully read the manual that came with your expansion card.
- Always turn off the computer and unplug the power cord from the power outlet before installing an
 expansion card to prevent hardware damage.

1-6 Back Panel Connectors



PS/2 Keyboard and PS/2 Mouse Port

Use the upper port (green) to connect a PS/2 mouse and the lower port (purple) to connect a PS/2 keyboard.

Parallel Port

Use the parallel port to connect devices such as a printer, scanner and etc. The parallel port is also called a printer port.

Serial Port

Use the serial port to connect devices such as a mouse, modem or other peripherals.

O D-Sub Port

The D-Sub port supports a 15-pin D-Sub connector and supports a maximum resolution of 1920x1200@60 Hz (the actual resolutions supported depend on the monitor being used). Connect a monitor that supports D-Sub connection to this port.

USB 3.0/2.0 Port

The USB 3.0 port supports the USB 3.0 specification and is compatible to the USB 2.0/1.1 specification. Use this port for USB devices.

① Only for GA-H110M-DS2.

② Only for GA-H110M-DS2 DDR3.

RJ-45 LAN Port

The Gigabit Ethernet LAN port provides Internet connection at up to 1 Gbps data rate. The following describes the states of the LAN port LEDs.



Connection/Speed LED:		
State Description		
Orange	1 Gbps data rate	
Green	100 Mbps data rate	
Off	10 Mbps data rate	

Activity LED:	
State	Description
Blinking	Data transmission or receiving is occurring
Off	No data transmission or receiving is occurring

USB 2.0/1.1 Port

The USB port supports the USB 2.0/1.1 specification. Use this port for USB devices.

D Line In (Blue)

The line in jack. Use this audio jack for line in devices such as an optical drive, walkman, etc.

Line Out (Green)

The line out jack. Use this audio jack for a headphone or 2-channel speaker. This jack can be used to connect front speakers in a 4/5.1/7.1-channel audio configuration.

Mic In (Pink)

The Mic in jack.

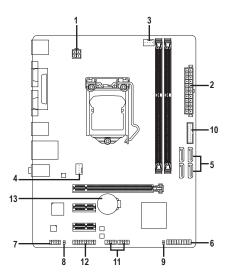


To configure 7.1-channel audio, you have to use an HD front panel audio module and enable the multi-channel audio feature through the audio driver. Please visit GIGABYTE's website for more software information.



- When removing the cable connected to a back panel connector, first remove the cable from your
 device and then remove it from the motherboard.
- When removing the cable, pull it straight out from the connector. Do not rock it side to side to prevent an electrical short inside the cable connector.

1-7 Internal Connectors



1)	ATX_12V	8)	SPDIF_O
2)	ATX	9)	CLR_CMOS
3)	CPU_FAN	10)	F_USB30
4)	SYS_FAN	11)	F_USB1/F_USB2
5)	SATA3 0/1/2/3	12)	TPM
6)	F_PANEL	13)	BAT
7)	F_AUDIO		



Read the following guidelines before connecting external devices:

- First make sure your devices are compliant with the connectors you wish to connect.
- Before installing the devices, be sure to turn off the devices and your computer. Unplug the power cord from the power outlet to prevent damage to the devices.
- After installing the device and before turning on the computer, make sure the device cable has been securely attached to the connector on the motherboard.

1/2) ATX 12V/ATX (2x2 12V Power Connector and 2x12 Main Power Connector)

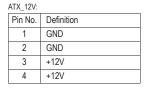
With the use of the power connector, the power supply can supply enough stable power to all the components on the motherboard. Before connecting the power connector, first make sure the power supply is turned off and all devices are properly installed. The power connector possesses a foolproof design. Connect the power supply cable to the power connector in the correct orientation.

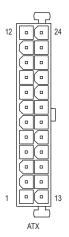
The 12V power connector mainly supplies power to the CPU. If the 12V power connector is not connected, the computer will not start.



To meet expansion requirements, it is recommended that a power supply that can withstand high power consumption be used (500W or greater). If a power supply is used that does not provide the required power, the result can lead to an unstable or unbootable system.







ATX:			
Pin No.	Definition	Pin No.	Definition
1	3.3V	13	3.3V
2	3.3V	14	-12V
3	GND	15	GND
4	+5V	16	PS_ON (soft On/Off)
5	GND	17	GND
6	+5V	18	GND
7	GND	19	GND
8	Power Good	20	NC
9	5VSB (stand by +5V)	21	+5V
10	+12V	22	+5V
11	+12V (Only for 2x12-pin	23	+5V (Only for 2x12-pin ATX)
10	ATX)	24	CND (Only for 2y12 nin
12	3.3V (Only for 2x12-pin ATX)	24	GND (Only for 2x12-pin ATX)

3/4) CPU_FAN/SYS_FAN (Fan Headers)

The fan headers on this motherboard are 4-pin. Most fan headers possess a foolproof insertion design. When connecting a fan cable, be sure to connect it in the correct orientation (the black connector wire is the ground wire). The speed control function requires the use of a fan with fan speed control design. For optimum heat dissipation, it is recommended that a system fan be installed inside the chassis.



CPU_FAN:				
Pin No.	Definition			
1	GND			
2	+12V			
3	Sense			
4	Speed Control			



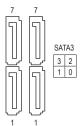
SYS_FAN:				
Pin No.	Definition			
1	GND			
2	Speed Control			
3	Sense			
4	VCC			



- Be sure to connect fan cables to the fan headers to prevent your CPU and system from overheating.
 Overheating may result in damage to the CPU or the system may hang.
- These fan headers are not configuration jumper blocks. Do not place a jumper cap on the headers.

5) SATA3 0/1/2/3 (SATA 6Gb/s Connectors)

The SATA connectors conform to SATA 6Gb/s standard and are compatible with SATA 3Gb/s and SATA 1.5Gb/s standard. Each SATA connector supports a single SATA device.



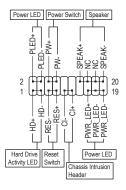
Pin No.	Definition
1	GND
2	TXP
3	TXN
4	GND
5	RXN
6	RXP
7	GND



To enable hot-plugging for the SATA ports, refer to Chapter 2, "BIOS Setup," "Peripherals\SATA Configuration." for more information.

6) F_PANEL (Front Panel Header)

Connect the power switch, reset switch, speaker, chassis intrusion switch/sensor and system status indicator on the chassis to this header according to the pin assignments below. Note the positive and negative pins before connecting the cables.



• PLED/PWR_LED (Power LED):

System Status	LED
S0	On
S3/S4/S5	Off

Connects to the power status indicator on the chassis front panel. The LED is on when the system is operating. The LED is off when the system is in S3/S4 sleep state or powered off (S5).

PW (Power Switch):

Connects to the power switch on the chassis front panel. You may configure the way to turn off your system using the power switch (refer to Chapter 2, "BIOS Setup," "Power Management," for more information).

· SPEAK (Speaker):

Connects to the speaker on the chassis front panel. The system reports system startup status by issuing a beep code. One single short beep will be heard if no problem is detected at system startup.

HD (Hard Drive Activity LED):

Connects to the hard drive activity LED on the chassis front panel. The LED is on when the hard drive is reading or writing data.

· RES (Reset Switch):

Connects to the reset switch on the chassis front panel. Press the reset switch to restart the computer if the computer freezes and fails to perform a normal restart.

· CI (Chassis Intrusion Header):

Connects to the chassis intrusion switch/sensor on the chassis that can detect if the chassis cover has been removed. This function requires a chassis with a chassis intrusion switch/sensor.

NC: No connection.



The front panel design may differ by chassis. A front panel module mainly consists of power switch, reset switch, power LED, hard drive activity LED, speaker and etc. When connecting your chassis front panel module to this header, make sure the wire assignments and the pin assignments are matched correctly.

7) F AUDIO (Front Panel Audio Header)

The front panel audio header supports Intel High Definition audio (HD) and AC'97 audio. You may connect your chassis front panel audio module to this header. Make sure the wire assignments of the module connector match the pin assignments of the motherboard header. Incorrect connection between the module connector and the motherboard header will make the device unable to work or even damage it.

For HD Front Panel Audio:



-or HD Front Panel Audio:					
Pin No.	Definition	Pin No.	Definition		
1	MIC2_L	6	Sense		
2	GND	7	FAUDIO_JD		
3	MIC2_R	8	No Pin		
4	-ACZ_DET	9	LINE2_L		
5	LINE2_R	10	Sense		

For AC'97 Front Panel Audio:

Pin No.	Definition	Pin No.	Definition
1	MIC	6	NC
2	GND	7	NC
3	MIC Power	8	No Pin
4	NC	9	Line Out (L)
5	Line Out (R)	10	NC



- The front panel audio header supports HD audio by default.
- Audio signals will be present on both of the front and back panel audio connections simultaneously.
- Some chassis provide a front panel audio module that has separated connectors on each wire instead of a single plug. For information about connecting the front panel audio module that has different wire assignments, please contact the chassis manufacturer.

8) SPDIF_O (S/PDIF Out Header)

This header supports digital S/PDIF Out and connects a S/PDIF digital audio cable (provided by expansion cards) for digital audio output from your motherboard to certain expansion cards like graphics cards and sound cards. For example, some graphics cards may require you to use a S/PDIF digital audio cable for digital audio output from your motherboard to your graphics card if you wish to connect an HDMI display to the graphics card and have digital audio output from the HDMI display at the same time. For information about connecting the S/PDIF digital audio cable, carefully read the manual for your expansion card.



Pin No.	Definition
1	SPDIFO
2	GND

9) CLR_CMOS (Clear CMOS Jumper)

Use this jumper to clear the BIOS configuration and reset the CMOS values to factory defaults. To clear the CMOS values, use a metal object like a screwdriver to touch the two pins for a few seconds.

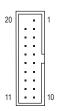
- Open: Normal
- Short: Clear CMOS Values



- Always turn off your computer and unplug the power cord from the power outlet before clearing the CMOS values.
- After system restart, go to BIOS Setup to load factory defaults (select Load Optimized Defaults) or manually configure the BIOS settings (refer to Chapter 2, "BIOS Setup," for BIOS configurations).

10) F_USB30 (USB 3.0/2.0 Header)

The header conforms to USB 3.0/2.0 specification and each header can provide two USB ports. For purchasing the optional 3.5" front panel that provides two USB 3.0/2.0 ports, please contact the local dealer.



Pin No.	Definition	Pin No.	Definition
1	VBUS	11	D2+
2	SSRX1-	12	D2-
3	SSRX1+	13	GND
4	GND	14	SSTX2+
5	SSTX1-	15	SSTX2-
6	SSTX1+	16	GND
7	GND	17	SSRX2+
8	D1-	18	SSRX2-
9	D1+	19	VBUS
10	NC	20	No Pin

11) F_USB1/F_USB2 (USB 2.0/1.1 Headers)

The headers conform to USB 2.0/1.1 specification. Each USB header can provide two USB ports via an optional USB bracket. For purchasing the optional USB bracket, please contact the local dealer.



Pin No.	Definition	Pin No.	Definition
1	Power (5V)	6	USB DY+
2	Power (5V)	7	GND
3	USB DX-	8	GND
4	USB DY-	9	No Pin
5	USB DX+	10	NC



- Do not plug the IEEE 1394 bracket (2x5-pin) cable into the USB 2.0/1.1 header.
- Prior to installing the USB bracket, be sure to turn off your computer and unplug the power cord from the power outlet to prevent damage to the USB bracket.

12) TPM (Trusted Platform Module Header)

You may connect a TPM (Trusted Platform Module) to this header.



Pin No.	Definition	Pin No.	Definition
1	LCLK	11	LAD0
2	GND	12	GND
3	LFRAME	13	NC
4	No Pin	14	NC
5	LRESET	15	SB3V
6	NC	16	SERIRQ
7	LAD3	17	GND
8	LAD2	18	NC
9	VCC3	19	NC
10	LAD1	20	SUSCLK

13) BAT (Battery)

The battery provides power to keep the values (such as BIOS configurations, date, and time information) in the CMOS when the computer is turned off. Replace the battery when the battery voltage drops to a low level, or the CMOS values may not be accurate or may be lost.



You may clear the CMOS values by removing the battery:

- 1. Turn off your computer and unplug the power cord.
- Gently remove the battery from the battery holder and wait for one minute. (Or use a metal object like a screwdriver to touch the positive and negative terminals of the battery holder, making them short for 5 seconds.)
- 3. Replace the battery.
- 4. Plug in the power cord and restart your computer.



- Always turn off your computer and unplug the power cord before replacing the battery.
- Replace the battery with an equivalent one. Danger of explosion if the battery is replaced with an incorrect model.
- Contact the place of purchase or local dealer if you are not able to replace the battery by yourself
 or uncertain about the battery model.
- When installing the battery, note the orientation of the positive side (+) and the negative side (-) of the battery (the positive side should face up).
- Used batteries must be handled in accordance with local environmental regulations.

Chapter 2 BIOS Setup

BIOS (Basic Input and Output System) records hardware parameters of the system in the CMOS on the motherboard. Its major functions include conducting the Power-On Self-Test (POST) during system startup, saving system parameters and loading operating system, etc. BIOS includes a BIOS Setup program that allows the user to modify basic system configuration settings or to activate certain system features.

When the power is turned off, the battery on the motherboard supplies the necessary power to the CMOS to keep the configuration values in the CMOS.

To access the BIOS Setup program, press the <Delete> key during the POST when the power is turned on. To upgrade the BIOS, use either the GIGABYTE Q-Flash or @BIOS utility.

- Q-Flash allows the user to quickly and easily upgrade or back up BIOS without entering the operating system.
- @BIOS is a Windows-based utility that searches and downloads the latest version of BIOS from the Internet
 and updates the BIOS.



- Because BIOS flashing is potentially risky, if you do not encounter problems using the current version of BIOS, it is recommended that you not flash the BIOS. To flash the BIOS, do it with caution. Inadequate BIOS flashing may result in system malfunction.
- It is recommended that you not alter the default settings (unless you need to) to prevent system
 instability or other unexpected results. Inadequately altering the settings may result in system's failure
 to boot. If this occurs, try to clear the CMOS values and reset the board to default values. (Refer
 to the "Load Optimized Defaults" section in this chapter or introductions of the battery/clear CMOS
 jumper in Chapter 1 for how to clear the CMOS values.)

2-1 Startup Screen

The following startup Logo screen will appear when the computer boots. (Sample BIOS Version: F2)



On the main menu of the BIOS Setup program, press arrow keys to move among the items and press <Enter> to accept or enter a sub-menu. Or you can use your mouse to select the item you want.



- When the system is not stable as usual, select the **Load Optimized Defaults** item to set your system to its defaults. The BIOS Setup menus described in this chapter are for reference only and may differ by BIOS version.
- 2-2 M.I.T.



This section provides information on the BIOS version, CPU base clock, CPU frequency, memory frequency, total memory size, CPU temperature and CPU voltage, etc.



Whether the system will work stably with the overclock/overvoltage settings you made is dependent on your overall system configurations. Incorrectly doing overclock/overvoltage may result in damage to CPU, chipset, or memory and reduce the useful life of these components. This page is for advanced users only and we recommend you not to alter the default settings to prevent system instability or other unexpected results. (Inadequately altering the settings may result in system's failure to boot. If this occurs, clear the CMOS values and reset the board to default values.)

M.I.T. Current Status

This screen provides information on CPU/memory frequencies/parameters.

Advanced Frequency Settings

Graphics Slice Ratio

Allows you to set the Graphics Slice Ratio.

Graphics UnSlice Ratio

Allows you to set the Graphics UnSlice Ratio.

→ CPU Clock Ratio

Allows you to alter the clock ratio for the installed CPU. The adjustable range is dependent on the CPU being installed.

□ CPU Frequency

Displays the current operating CPU frequency.

Advanced CPU Core Settings

CPU Clock Ratio, CPU Frequency

The settings above are synchronous to those under the same items on the **Advanced Frequency Settings** menu.

Uncore Ratio

Allows you to set the CPU Uncore ratio. The adjustable range is dependent on the CPU being used.

Uncore Frequency

Displays the current CPU Uncore frequency.

CPU Flex Ratio Override

Enables or disables the CPU Flex Ratio. The maximum CPU clock ratio will be based on the CPU Flex Ratio Settings value if CPU Clock Ratio is set to Auto. (Default: Disabled)

☐ CPU Flex Ratio Settings

Allows you to set the CPU Flex Ratio. The adjustable range may vary by CPU. (Default: 20)

Intel(R) Turbo Boost Technology (Note)

Allows you to determine whether to enable the Intel CPU Turbo Boost technology. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

→ Turbo Ratio (Note)

Allows you to set the CPU Turbo ratios for different number of active cores. **Auto** sets the CPU Turbo ratios according to the CPU specifications. (Default: Auto)

Power Limit TDP (Watts) / Power Limit Time

Allows you to set the power limit for CPU Turbo mode and how long it takes to operate at the specified power limit. If the specified value is exceeded, the CPU will automatically reduce the core frequency in order to reduce the power. **Auto** sets the current limit according to the CPU specifications. (Default: Auto)

Core Current Limit (Amps)

Allows you to set a current limit for CPU Turbo mode. When the CPU current exceeds the specified current limit, the CPU will automatically reduce the core frequency in order to reduce the current. **Auto** sets the power limit according to the CPU specifications. (Default: Auto)

○ No. of CPU Cores Enabled (Note)

Allows you to select the number of CPU cores to enable in an Intel® multi-core CPU (the number of CPU cores may vary by CPU). **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

(Note) This item is present only when you install a CPU that supports this feature. For more information about Intel® CPUs' unique features, please visit Intel's website.

Hyper-Threading Technology (Note)

Allows you to determine whether to enable multi-threading technology when using an Intel® CPU that supports this function. This feature only works for operating systems that support multi-processor mode. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

□ CPU Enhanced Halt (C1E) (Note)

Enables or disables Intel® CPU Enhanced Halt (C1E) function, a CPU power-saving function in system halt state. When enabled, the CPU core frequency and voltage will be reduced during system halt state to decrease power consumption. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

Allows you to determine whether to let the CPU enter C3 mode in system halt state. When enabled, the CPU core frequency and voltage will be reduced during system halt state to decrease power consumption. The C3 state is a more enhanced power-saving state than C1. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

Allows you to determine whether to let the CPU enter C6/C7 mode in system halt state. When enabled, the CPU core frequency and voltage will be reduced during system halt state to decrease power consumption. The C6/C7 state is a more enhanced power-saving state than C3. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

○ C8 State Support (Note)

Allows you to determine whether to let the CPU enter C8 mode in system halt state. When enabled, the CPU core frequency and voltage will be reduced during system halt state to decrease power consumption. The C8 state is a more enhanced power-saving state than C6/C7. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

→ Package C State Limit (Note)

Allows you to specify the C-state limit for the processor. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

CPU Thermal Monitor (Note)

Enables or disables Intel® Thermal Monitor function, a CPU overheating protection function. When enabled, the CPU core frequency and voltage will be reduced when the CPU is overheated. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

Enables or disables Enhanced Intel® Speed Step Technology (EIST). Depending on CPU loading, Intel EIST technology can dynamically and effectively lower the CPU voltage and core frequency to decrease average power consumption and heat production. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

▽ Voltage Optimization

Allows you to determine whether to enable voltage optimization to reduce power consumption. (Default: Enabled)

→ RSR

Allows you to determine whether to automatically lower the CPU turbo ratio if the CPU voltage/temperature is too high. (Default: Enabled)

Hardware Prefetcher

Allows you to determine whether to enable hardware prefetcher to prefetch data and instructions from the memory into the cache. (Default: Enabled)

Adiacent Cache Line Prefetch

Allows you to determine whether to enable the adjacent cache line prefetch mechanism that lets the processor retrieve the requested cache line as well as the subsequent cache line. (Default: Enabled)

(Note) This item is present only when you install a CPU that supports this feature. For more information about Intel® CPUs' unique features, please visit Intel's website.

System Memory Multiplier

Allows you to set the system memory multiplier. **Auto** sets memory multiplier according to memory SPD data. (Default: Auto)

The first memory frequency value is the normal operating frequency of the memory being used; the second is the memory frequency that is automatically adjusted according to the **System Memory Multiplier** settings.

Advanced Memory Settings

System Memory Multiplier, Memory Frequency(MHz)

The settings above are synchronous to those under the same items on the **Advanced Frequency Settings** menu.

Provides memory detection and training methods.

➤ Auto Lets the BIOS automatically configure this setting. (Default)

▶ Enable Fast Boot Skip memory detection and training in some specific criteria for faster memory

boot.

▶ Disable Fast Boot Detect and train memory at every single boot.

☐ Memory Enhancement Settings

Provides several memory performance enhancement settings: Normal (basic performance), Relax OC, Enhanced Stability, and Enhanced Performance. (Default: Normal)

Memory Timing Mode

Manual and Advanced Manual allows the Memory Multiplier Tweaker, Channel Interleaving, Rank Interleaving, and memory timing settings below to be configurable. Options are: Auto (default), Manual, Advanced Manual.

Profile DDR Voltage

Displays the memory voltage.

Memory Multiplier Tweaker

Provides different levels of memory auto-tuning. (Default: Auto)

Channel Interleaving

Enables or disables memory channel interleaving. Enabled allows the system to simultaneously access different channels of the memory to increase memory performance and stability. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

□ Rank Interleaving

Enables or disables memory rank interleaving. Enabled allows the system to simultaneously access different ranks of the memory to increase memory performance and stability. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

IMC Timing Settings

This sub-menu provides options for tuning memory compatibility and stability.

Channel A/B Memory Sub Timings

This sub-menu provides memory timing settings for each channel of memory. The respective timing setting screens are configurable only when **Memory Timing Mode** is set to **Manual** or **Advanced Manual**. Note: Your system may become unstable or fail to boot after you make changes on the memory timings. If this occurs, please reset the board to default values by loading optimized defaults or clearing the CMOS values.

(Note) This item is present only when you install a CPU and a memory module that support this feature.

Advanced Voltage Settings

Advanced Power Settings

☐ CPU Vcore Loadline Calibration

Allows you to configure Load-Line Calibration for the CPU Vcore voltage. Selecting a higher level keeps the CPU Vcore voltage more consistent with what is set in BIOS under heavy load. **Auto** lets the BIOS automatically configure this setting and sets the voltage following Intel®s specifications. (Default: Auto)

VAXG Loadline Calibration

Allows you to configure Load-Line Calibration for the CPU VAXG voltage. Selecting a higher level keeps the CPU VAXG voltage more consistent with what is set in BIOS under heavy load. **Auto** lets the BIOS automatically configure this setting and sets the voltage following Intel®s specifications. (Default: Auto)

► CPU Core Voltage Control

This section provides CPU voltage control options.

DRAM Voltage Control

This section provides memory voltage control options.

▶ Internal VR Control

This section provides VR voltage control options.

PC Health Status

▶ Enabled

Reset Case Open Status

▶ Disabled Keeps or clears the record of previous chassis intrusion status. (Default)

Clears the record of previous chassis intrusion status and the **Case Open** field will show "No" at next boot.

Displays the detection status of the chassis intrusion detection device attached to the motherboard CI header. If the system chassis cover is removed, this field will show "Yes", otherwise it will show "No". To clear the chassis intrusion status record, set **Reset Case Open Status** to **Enabled**, save the settings to the CMOS, and then restart your system.

CPU Vcore/CPU VCCSA/DRAM Channel A/B Voltage/+3.3V/+5V/+12V/CPU VAXG Displays the current system voltages.

Displays current CPU/system temperature.

CPU/System Fan Speed

Displays current CPU/system fan speeds.

CPU/System Temperature Warning

Sets the warning threshold for CPU/system temperature. When temperature exceeds the threshold, BIOS will emit warning sound. Options are: Disabled (default), 60°C/140°F, 70°C/158°F, 80°C/176°F, 90°C/194°F.

CPU/System Fan Fail Warning

Allows the system to emit warning sound if the fan is not connected or fails. Check the fan condition or fan connection when this occurs. (Default: Disabled)

CPU Fan Speed Control (CPU FAN Connector)

Allows you to determine whether to enable the fan speed control function and adjust the fan speed.

Normal Allows the fan to run at different speeds according to the CPU temperature. You

can adjust the fan speed with System Information Viewer based on your system requirements. (Default)

➤ Silent Allows the fan to run at slow speeds.

Manual Allows you to control the fan speed under the Fan Speed Percentage item.

➤ Full Speed Allows the fan to run at full speeds.

→ Fan Speed Percentage

Allows you to control the fan speed. This item is configurable only when **CPU Fan Speed Control** is set to **Manual**. Options are: 0.75 PWM value $/^{\circ}$ C ~ 2.50 PWM value $/^{\circ}$ C.

System Fan Speed Control (SYS_FAN Connector)

Allows you to determine whether to enable the fan speed control function and adjust the fan speed.

Normal Allows the fan to run at different speeds according to the system temperature. You can adjust the fan speed with System Information Viewer based on your system

requirements. (Default)

Silent Allows the fan to run at slow speeds.

→ Manual Allows you to control the fan speed under the Fan Speed Percentage item.

➤ Full Speed Allows the fan to run at full speeds.

Allows you to control the fan speed. This item is configurable only when **System Fan Speed Control** is set to **Manual**. Options are: 0.75 PWM value $/^{\circ}$ C ~ 2.50 PWM value $/^{\circ}$ C.

▶ Miscellaneous Settings

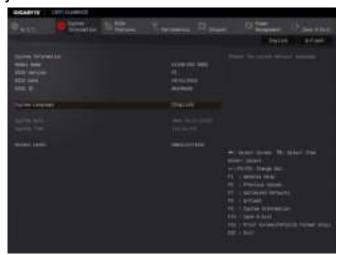
Max Link Speed

Allows you to set the operation mode of the PCI Express slots to Gen 1, Gen 2, or Gen 3. Actual operation mode is subject to the hardware specification of each slot. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

→ 3DMark01 Enhancement

Allows you to determine whether to enhance some legacy benchmark performance. (Default: Disabled)

2-3 System Information



This section provides information on your motherboard model and BIOS version. You can also select the default language used by the BIOS and manually set the system time.

System Language Selects the default language used by the BIOS.

System Date

Sets the system date. The date format is week (read-only), month, date, and year. Use <Enter> to switch between the Month, Date, and Year fields and use the <Page Up> or <Page Down> key to set the desired value.

System Time

Sets the system time. The time format is hour, minute, and second. For example, 1 p.m. is 13:00:00. Use <Enter> to switch between the Hour, Minute, and Second fields and use the <Page Up> or <Page Down> key to set the desired value.

→ Access Level

Displays the current access level depending on the type of password protection used. (If no password is set, the default will display as **Administrator**.) The Administrator level allows you to make changes to all BIOS settings; the User level only allows you to make changes to certain BIOS settings but not all.

2-4 BIOS Features



Boot Option Priorities

Specifies the overall boot order from the available devices.

Removable storage devices that support GPT format will be prefixed with "UEFI:" string on the boot device list. To boot from an operating system that supports GPT partitioning, select the device prefixed with "UEFI:" string.

Or if you want to install an operating system that supports GPT partitioning such as Windows 7 64-bit, select the optical drive that contains the Windows 7 64-bit installation disk and is prefixed with "UEFI:" string.

→ Hard Drive/CD/DVD ROM Drive/Floppy Drive/Network Device BBS Priorities

Specifies the boot order for a specific device type, such as hard drives, optical drives, floppy disk drives, and devices that support Boot from LAN function, etc. Press <Enter> on this item to enter the submenu that presents the devices of the same type that are connected. This item is present only if at least one device for this type is installed.

→ Bootup NumLock State

Enables or disables Numlock feature on the numeric keypad of the keyboard after the POST. (Default: On)

Specifies whether a password is required every time the system boots, or only when you enter BIOS Setup. After configuring this item, set the password(s) under the Administrator Password/User Password item.

➤ Setup A password is only required for entering the BIOS Setup program.

▶ System A password is required for booting the system and for entering the BIOS Setup program.

(Default)

→ Full Screen LOGO Show

Allows you to determine whether to display the GIGABYTE Logo at system startup. **Disabled** skips the GIGABYTE Logo when the system starts up. (Default: Enabled)

→ Fast Boot

Enables or disables Fast Boot to shorten the OS boot process. **Ultra Fast** provides the fastest bootup speed. (Default: Disabled)

→ SATA Support

▶ All Sata Devices All SATA devices are functional in the operating system and during the POST.

(Default)

▶ Last Boot HDD Only Except for the previous boot drive, all SATA devices are disabled before the OS

boot process completes.

This item is configurable only when Fast Boot is set to Enabled or Ultra Fast.

▽ VGA Support

Allows you to select which type of operating system to boot.

➤ Auto Enables legacy option ROM only.

➤ EFI Driver Enables EFI option ROM. (Default)

This item is configurable only when Fast Boot is set to Enabled or Ultra Fast.

□ USB Support

Disabled All USB devices are disabled before the OS boot process completes.
 Full Initial All USB devices are functional in the operating system and during the POST.
 ▶ Partial Initial Part of the USB devices are disabled before the OS boot process completes.

(Default)

This item is configurable only when **Fast Boot** is set to **Enabled**. This function is disabled when **Fast Boot** is set to Ultra Fast.

PS2 Devices Support

▶ Disabled All PS/2 devices are disabled before the OS boot process completes.

► Enabled All PS/2 devices are functional in the operating system and during the POST.

(Default)

This item is configurable only when **Fast Boot** is set to **Enabled**. This function is disabled when **Fast Boot** is set to Ultra Fast.

NetWork Stack Driver Support

▶ Disabled Disables booting from the network. (Default)

➤ Enabled Enables booting from the network.

This item is configurable only when Fast Boot is set to Enabled or Ultra Fast.

Next Boot After AC Power Loss

Normal Boot Enables normal bootup upon the return of the AC power. (Default)
 ▶ Fast Boot Keeps the Fast Boot settings upon the return of the AC power.

This item is configurable only when Fast Boot is set to Enabled or Ultra Fast.

→ Windows 8/10 Features

Allows you to select the operating system to be installed. (Default: Other OS)

☐ CSM Support

Enables or disables UEFI CSM (Compatibility Support Module) to support a legacy PC boot process.

➤ Enabled Enables UEFI CSM. (Default)

▶ Disabled Disables UEFI CSM and supports UEFI BIOS boot process only.

This item is configurable only when Windows 8/10 Features is set to Windows 8/10 or Windows 8/10 WHQL.

□ LAN PXE Boot Option ROM

Allows you to select whether to enable the legacy option ROM for the LAN controller. (Default: Disabled) This item is configurable only when **CSM Support** is set to **Enabled**.

Storage Boot Option Control

Allows you to select whether to enable the UEFI or legacy option ROM for the storage device controller.

▶ Disabled Disables option ROM.

▶ UEFI Only Enables UEFI option ROM only.

▶ Legacy Only Enables legacy option ROM only. (Default) This item is configurable only when CSM Support is set to Enabled.

Other PCI Device ROM Priority

Allows you to select whether to enable the UEFI or Legacy option ROM for the PCI device controller other than the LAN, storage device, and graphics controllers.

▶ Disabled Disables option ROM.

▶ UEFI Only Enables UEFI option ROM only. (Default)

▶ Legacy Only Enables legacy option ROM only.

This item is configurable only when CSM Support is set to Enabled.

Network Stack

Disables or enables booting from the network to install a GPT format OS, such as installing the OS from the Windows Deployment Services server. (Default: Disabled)

□ Ipv6 PXE Support

Enables or disables IPv6 PXE Support. This item is configurable only when **Network Stack** is enabled.

☐ Ipv4 PXE Support

Enables or disables IPv4 PXE Support. This item is configurable only when **Network Stack** is enabled.

Administrator Password

Allows you to configure an administrator password. Press <Enter> on this item, type the password, and then press <Enter>. You will be requested to confirm the password. Type the password again and press <Enter>. You must enter the administrator password (or user password) at system startup and when entering BIOS Setup. Differing from the user password, the administrator password allows you to make changes to all BIOS settings.

User Password

Allows you to configure a user password. Press <Enter> on this item, type the password, and then press <Enter>. You will be requested to confirm the password. Type the password again and press <Enter>. You must enter the administrator password (or user password) at system startup and when entering BIOS Setup. However, the user password only allows you to make changes to certain BIOS settings but not all. To cancel the password, press <Enter> on the password item and when requested for the password, enter the correct one first. When prompted for a new password, press <Enter> without entering any password. Press <Enter> again when prompted to confirm.

NOTE: Before setting the User Password, be sure to set the Administrator Password first.

2-5 Peripherals



Intel Platform Trust Technology (PTT)

Enables or disables Intel® PTT Technology. (Default: Disabled)

Initial Display Output

Specifies the first initiation of the monitor display from the installed PCI Express graphics card or the onboard graphics.

▶ IGFX Sets the onboard graphics as the first display.

▶ PCle 1 Slot Sets the graphics card on the PCIEX16 slot as the first display. (Default)

OnBoard LAN Controller

Enables or disables the onboard LAN function. (Default: Enabled)

If you wish to install a 3rd party add-in network card instead of using the onboard LAN, set this item to Disabled.

→ Audio LED

Enables or disables the onboard audio LED. (Default: On)

Allows USB keyboard/mouse to be used in MS-DOS. (Default: Enabled)

Determines whether to enable XHCI Hand-off feature for an operating system without XHCI Hand-off support. (Default: Disabled)

USB Mass Storage Driver Support

Enables or disables support for USB storage devices. (Default: Enabled)

USB Storage Devices

Displays a list of connected USB mass storage devices. This item appears only when a USB storage device is installed.

OffBoard SATA Controller Configuration

Displays information on your PCle SSD if installed.

► Trusted Computing 2.0

This sub-menu appears only when Intel Platform Trust Technology is set to Enabled.

☐ Security Device Support

Enables or disables Trusted Platform Module (TPM). (Default: Enable)

→ Pending operation

To clear TPM related settings, set this item to **TPM Clear**. (Default: None)

→ TPM 20 InterfaceType

Allows you to select the communication interface for the TPM 2.0 device. Set to **External TPM2.0** if you install an Infineon TPM 2.0 module (optional). (Default: PTT)

Device Select

Allows you to select whether to support TPM 1.2 or TPM 2.0 device. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

▶ Super IO Configuration

→ Serial Port 1

Enables or disables the onboard serial port. (Default: Enabled)

→ Parallel Port

Enables or disables the onboard parallel port. (Default: Enabled)

Intel(R) Bios Guard Technology

Enables or disables the Intel® BIOS Guard feature, which protects the BIOS from malicious attacks.

SATA Configuration

→ SATA Controller(s)

Enables or disables the integrated SATA controllers. (Default: Enabled)

→ SATA Mode Selection

AHCI

Configures the SATA controllers to AHCI mode. Advanced Host Controller Interface (AHCI) is an interface specification that allows the storage driver to enable advanced Serial ATA features such as Native Command Queuing and hot plug. (Default)

→ Aggressive LPM Support

Enables or disables the power saving feature, ALPM (Aggressive Link Power Management), for the Chipset SATA controllers. (Default: Enabled)

→ Port 0/1/2/3

Enables or disables each SATA port. (Default: Enabled)

Hot plug

Enables or disable the hot plug capability for each SATA port. (Default: Disabled)

☐ External SATA

Enables or disables support for external SATA devices. (Default: Disabled)

NVMe Configuration

Displays information on your NVME PCIe SSD if installed.

▶ Realtek PCle GBE Family Controller

This sub-menu provides information on LAN configuration.

2-6 Chipset



→ VT-d (Note)

Enables or disables Intel® Virtualization Technology for Directed I/O. (Default: Disabled)

Enables or disables the onboard graphics function. (Default: Auto)

→ DVMT Pre-Allocated

Allows you to set the onboard graphics memory size. Options are: 32M~512M. (Default: 64M)

→ DVMT Total Gfx Mem

Allows you to allocate the DVMT memory size of the onboard graphics. Options are: 128M, 256M, MAX. (Default: 256M)

Audio Controller

Enables or disables the onboard audio function. (Default: Enabled)

If you wish to install a 3rd party add-in audio card instead of using the onboard audio, set this item to Disabled.

High Precision Timer

Enables or disables High Precision Event Timer (HPET) in the operating system. (Default: Enabled)

(Note) This item is present only when you install a CPU that supports this feature. For more information about Intel® CPUs' unique features, please visit Intel's website.

2-7 Power Management



→ AC BACK

Determines the state of the system after the return of power from an AC power loss.

→ Always Off
 → Always On
 The system stays off upon the return of the AC power. (Default)
 → Always On
 The system is turned on upon the return of the AC power.

➤ Memory The system returns to its last known awake state upon the return of the AC power.

Power On By Keyboard

Allows the system to be turned on by a PS/2 keyboard wake-up event.

Note: To use this function, you need an ATX power supply providing at least 1A on the +5VSB lead.

▶ Disabled Disables this function. (Default)

▶ Password Set a password with 1~5 characters to turn on the system.

▶ Keyboard 98 Press POWER button on the Windows 98 keyboard to turn on the system.

➤ Any Key Press any key to turn on the system.

Power On Password

Set the password when Power On By Keyboard is set to Password.

Press Enter> on this item and set a password with up to 5 characters and then press <Enter> to accept. To turn on the system, enter the password and press <Enter>.

Note: To cancel the password, press <Enter> on this item. When prompted for the password, press <Enter> again without entering the password to clear the password settings.

Power On By Mouse

Allows the system to be turned on by a PS/2 mouse wake-up event.

Note: To use this function, you need an ATX power supply providing at least 1A on the +5VSB lead.

Disabled Disables this function. (Default)Move the mouse to turn on the system.

▶ Double Click Double click on left button on the mouse to turn on the system.

ு ErP

Determines whether to let the system consume least power in S5 (shutdown) state. (Default: Disabled) Note: When this item is set to **Enabled**, the following functions will become unavailable: Resume by Alarm, PME event wake up, power on by mouse, power on by keyboard, and wake on LAN.

→ Soft-Off by PWR-BTTN

Configures the way to turn off the computer in MS-DOS mode using the power button.

▶ Instant-Off Press the power button and then the system will be turned off instantly. (Default)

▶ Delay 4 Sec. Press and hold the power button for 4 seconds to turn off the system. If the power button is pressed for less than 4 seconds, the system will enter suspend mode.

→ Power Loading

Enables or disables dummy load. When the power supply is at low load, a self-protection will activate causing it to shutdown or fail. If this occurs, please set to **Enabled**. **Auto** lets the BIOS automatically configure this setting. (Default: Auto)

Resume by Alarm

Determines whether to power on the system at a desired time. (Default: Disabled) If enabled, set the date and time as following:

- Wake up day: Turn on the system at a specific time on each day or on a specific day in a month.
- ▶ Wake up hour/minute/second: Set the time at which the system will be powered on automatically. Note: When using this function, avoid inadequate shutdown from the operating system or removal of the AC power, or the settings may not be effective.

Allows you to determine whether to let the onboard graphics enter standby mode to decrease power consumption. (Default: Enabled)

Platform Power Management

Enables or disables the Active State Power Management function (ASPM). (Default: Disabled)

→ PEG ASPM

Allows you to configure the ASPM mode for the device connected to the CPU PEG bus. This item is configurable only when **Platform Power Management** is set to **Enabled**. (Default: Enabled)

→ PCH ASPM

Allows you to configure the ASPM mode for the device connected to Chipset's PCI Express bus. This item is configurable only when **Platform Power Management** is set to **Enabled**. (Default: Enabled)

DMI Link ASPM Control

Allows you to configure the ASPM mode for both CPU side and Chipset side of the DMI link. This item is configurable only when **Platform Power Management** is set to **Enabled**. (Default: Enabled)

2-8 Save & Exit



→ Save & Exit Setup

Press <Enter> on this item and select **Yes**. This saves the changes to the CMOS and exits the BIOS Setup program. Select **No** or press <Esc> to return to the BIOS Setup Main Menu.

Exit Without Saving

Press <Enter> on this item and select **Yes**. This exits the BIOS Setup without saving the changes made in BIOS Setup to the CMOS. Select **No** or press <Esc> to return to the BIOS Setup Main Menu.

Press <Enter> on this item and select **Yes** to load the optimal BIOS default settings. The BIOS defaults settings help the system to operate in optimum state. Always load the Optimized defaults after updating the BIOS or after clearing the CMOS values.

→ Boot Override

Allows you to select a device to boot immediately. Press <Enter> on the device you select and select **Yes** to confirm. Your system will restart automatically and boot from that device.

This function allows you to save the current BIOS settings to a profile. You can create up to 8 profiles and save as Setup Profile 1~ Setup Profile 8. Press <Enter> to complete. Or you can select **Select File in HDD/FDD/USB** to save the profile to your storage device.

If your system becomes unstable and you have loaded the BIOS default settings, you can use this function to load the BIOS settings from a profile created before, without the hassles of reconfiguring the BIOS settings. First select the profile you wish to load and then press <Enter> to complete. You can select **Select File in HDD/FDD/USB** to input the profile previously created from your storage device or load the profile automatically created by the BIOS, such as reverting the BIOS settings to the last settings that worked properly (last known good record).

Chapter 3 Appendix

Drivers Installation



- Before installing the drivers, first install the operating system. (The following instructions use Windows 8.1 as the example operating system.)
- After installing the operating system, insert the motherboard driver disk into your optical drive. Click
 on the message "Tap to choose what happens with this disc" on the top-right corner of the screen
 and select "Run Run exe." (Or go to My Computer, double-click the optical drive and execute the
 Run exe program.)

"Xpress Install" will automatically scan your system and then list all of the drivers that are recommended to install. You can click the **Xpress Install** button and "Xpress Install" will install all of the selected drivers. Or click the arrow I icon to individually install the drivers you need.





Please visit GIGABYTE's website for more software information.



Please visit GIGABYTE's website for details on configuring the audio software.

Regulatory Statements

Regulatory Notices

This document must not be copied without our written permission, and the contents there of must not be imparted to a third party nor be used for any unauthorized purpose.

Contravention will be prosecuted. We believe that the information contained herein was accurate in all respects at the time of printing. GIGABYTE cannot, however, assume any responsibility for errors or omissions in this text. Also note that the information in this document is subject to change without notice and should not be construed as a commitment by GIGABYTE.

Our Commitment to Preserving the Environment

In addition to high-efficiency performance, all GIGABYTE motherboards fulfill European Union regulations for RoHS (Restriction of Certain Hazardous Substances in Electrical and Electronic Equipment) and WEEE (Waste Electrical and Electronic Equipment) environmental directives, as well as most major worldwide safety requirements. To prevent releases of harmful substances into the environment and to maximize the use of our natural resources, GIGABYTE provides the following information on how you can responsibly recycle or reuse most of the materials in your "end of life" product.

Restriction of Hazardous Substances (RoHS) Directive Statement

GIGABYTE products have not intended to add and safe from hazardous substances (Cd, Pb, Hg, Cr+6, PBDE and PBB). The parts and components have been carefully selected to meet RoHS requirement. Moreover, we at GIGABYTE are continuing our efforts to develop products that do not use internationally banned toxic chemicals.

Waste Electrical & Electronic Equipment (WEEE) Directive Statement

GIGABYTE will fulfill the national laws as interpreted from the 2002/96/EC WEEE (Waste Electrical and Electronic Equipment) directive. The WEEE Directive specifies the treatment, collection, recycling and disposal of electric and electronic devices and their components. Under the Directive, used equipment must be marked, collected separately, and disposed of properly.

WEEE Symbol Statement



The symbol shown below is on the product or on its packaging, which indicates that this product must not be disposed of with other waste. Instead, the device should be taken to the waste collection centers for activation of the treatment, collection, recycling and disposal procedure. The separate collection and recycling of your waste equipment at the time of disposal will help to conserve natural resources and ensure that it is recycled in a manner that protects human health and the environment.

For more information about where you can drop off your waste equipment for recycling, please contact your local government office, your household waste disposal service or where you purchased the product for details of environmentally safe recycling.

- When your electrical or electronic equipment is no longer useful to you, "take it back" to your local or regional
 waste collection administration for recycling.
- If you need further assistance in recycling, reusing in your "end of life" product, you may contact us at the Customer Care number listed in your product's user's manual and we will be glad to help you with your effort.

Finally, we suggest that you practice other environmentally friendly actions by understanding and using the energy-saving features of this product (where applicable), recycling the inner and outer packaging (including shipping containers) this product was delivered in, and by disposing of or recycling used batteries properly. With your help, we can reduce the amount of natural resources needed to produce electrical and electronic equipment, minimize the use of landfills for the disposal of "end of life" products, and generally improve our quality of life by ensuring that potentially hazardous substances are not released into the environment and are disposed of properly.

FCC Notice (U.S.A. Only)

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult a dealer or experienced TV/radio technician for help.

Canada, Industry Canada (IC) Notices / Canada, avis d'Industry Canada (IC)

- This Class B digital apparatus complies with Canadian ICES-003 and RSS-210.
- Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this
 device must accept any interference, including interference that may cause undesired operation of the device.
- Cet appareil numérique de classe B est conforme aux normes canadiennes ICES-003 et RSS-210.
- Son fonctionnement est soumis aux deux conditions suivantes: (1) cet appareil ne doit pas causer d'interférence et (2) cet appareil doit accepter toute interférence, notamment les interférences qui peuvent affecter son fonctionnement.



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